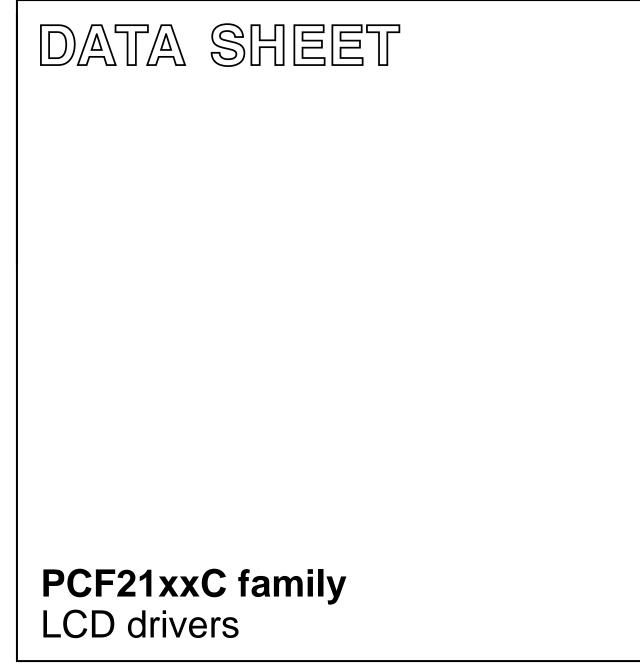
INTEGRATED CIRCUITS



Product specification Supersedes data of 1995 May 03 File under Integrated Circuits, IC12 1997 Mar 28



HILIPS

Philips Semiconductors

Product specification

LCD drivers

PCF21xxC family

CONTENTS

| 1 | FEATURES |
|---|---|
| 2 | GENERAL DESCRIPTION |
| 3 | QUICK REFERENCE DATA |
| 4 | ORDERING INFORMATION |
| 5 | BLOCK DIAGRAMS |
| 6 | PINNING |
| 6.1 6.2 6.3 | PCF2100C PCF2111C PCF2112C |
| 7 | FUNCTIONAL DESCRIPTION |
| 7.1 7.2 7.3 7.4 7.5 7.6 7.7 | PCF2100C PCF2111C PCF2112C Bus control logic Timing Input circuitry Expansion |
| 8 | LIMITING VALUES |
| 9 | HANDLING |
| 10 | DC CHARACTERISTICS |
| 11 | AC CHARACTERISTICS |
| 12 | PACKAGE OUTLINES |
| 13 | SOLDERING |
| 13.1 13.1.1 13.1.2 | Plastic dual in-line packages By dip or wave Repairing soldered joints |
| 13.2 13.2.1 | Plastic small outline packages By wave |
| 13.2.1 | By solder paste reflow |
| 13.2.3 | Repairing soldered joints (by hand-held soldering iron or pulse-heated solder tool) |
| 14 | DEFINITIONS |
| 15 | |

15 LIFE SUPPORT APPLICATIONS

PCF21xxC family

GENERAL DESCRIPTION

CMOS/NMOS compatible.

6.5 to 6.0 V.

The PCF21xxC family are single-chip, silicon gate CMOS LCD driver circuits. A 3-line bus (CBUS) structure enables

The devices have the same function and performance as

The maximum operating voltage required is reduced from

those of the PCF21xx family, which they supersede.

serial data transfer with microcontrollers. All inputs are

2

1 FEATURES

- Supply voltage 2.25 to 6.0 V
- Low current consumption
- Serial data input
- CBUS control
- One-point built-in oscillator
- Stand-alone or expanded system
- Power-on reset clear
- LCD segments
 - 40 (PCF2100C)
 - 64 (PCF2111C)
 - 32 (PCF2112C)
- Multiplex rate
 - 1:2 (PCF2100C)
 - 1:2 (PCF2111C)
 - 1:1 (PCF2112C)
- Word length
 - 22 bits (PCF2100C)
 - 34 bits (PCF2111C)
 - 34 bits (PCF2112C).

3 QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------|-------------------------------|--|------|------|------|------|
| V _{DD} | supply voltage | | 2.25 | - | 6.0 | V |
| I _{DD1} | supply current 1 | outputs open; CBUS inactive | - | 20 | 50 | μA |
| I _{DD2} | supply current 2 | outputs open; CBUS inactive; T _{amb} = 25 °C | - | 20 | 30 | μA |
| Po | power dissipation per output | | - | - | 100 | mW |
| T _{amb} | operating ambient temperature | | -40 | - | +85 | °C |
| T _{stg} | storage temperature | | -65 | - | +150 | °C |

4 ORDERING INFORMATION

| TYPE NUMBER NAME | | PACKAGE | |
|---------------------|-------|--|----------|
| | | DESCRIPTION | VERSION |
| PCF2100CP | DIP28 | plastic dual in-line package; 28 leads (600 mil) | SOT117-1 |
| PCF2100CT | SO28 | plastic small outline package; 28 leads; body width 7.5 mm | SOT136-1 |
| PCF2111CP | DIP40 | plastic dual in-line package; 40 leads (600 mil) | SOT129-1 |
| PCF2111CT | VSO40 | plastic very small outline package; 40 leads | SOT158-1 |
| PCF2112CP | DIP40 | plastic dual in-line package; 40 leads (600 mil) | SOT129-1 |
| PCF2112CT | VSO40 | plastic very small outline package; 40 leads | SOT158-1 |

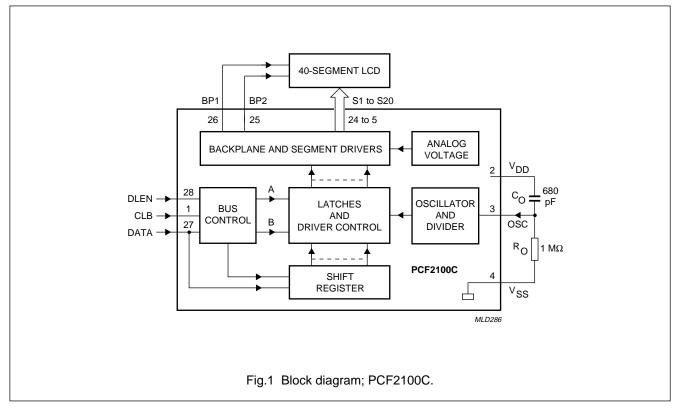
1997 Mar 28

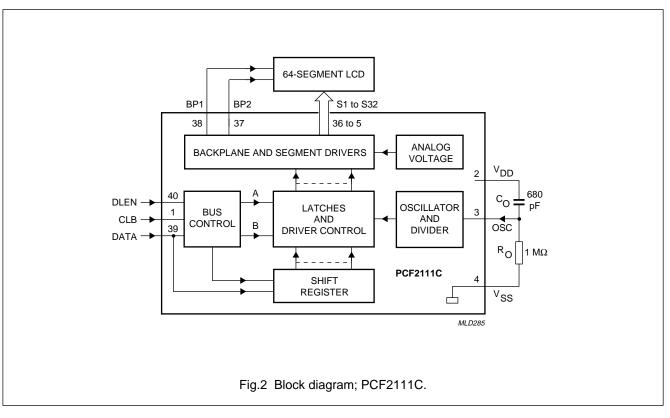
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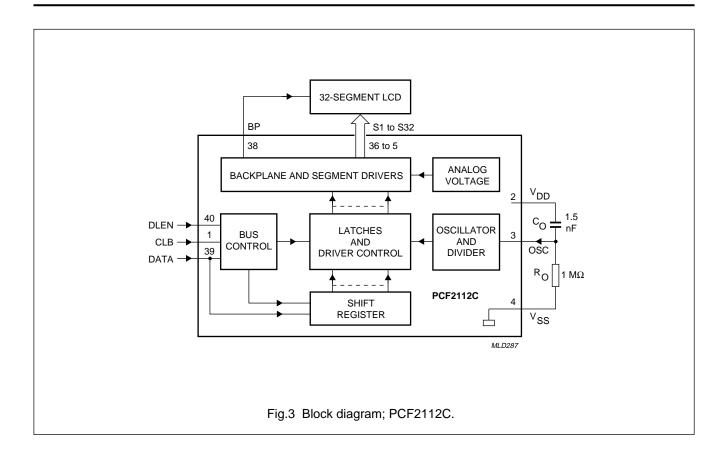
PCF21xxC family

5 BLOCK DIAGRAMS





PCF21xxC family



Product specification

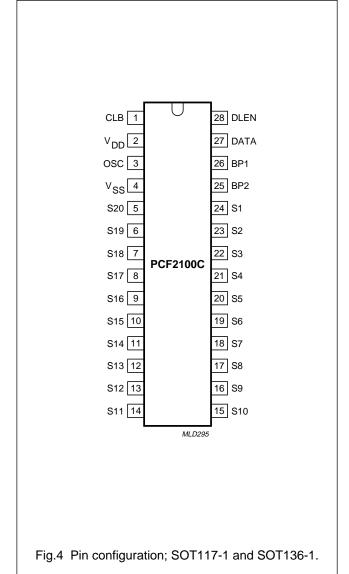
LCD drivers

PCF21xxC family

6 PINNING

6.1 PCF2100C

| SYMBOL | PIN | DESCRIPTION |
|-----------------|-----|-------------------------------|
| CLB | 1 | clock burst input (CBUS) |
| V _{DD} | 2 | supply voltage |
| OSC | 3 | oscillator input |
| V _{SS} | 4 | supply voltage ground |
| S20 | 5 | LCD driver output 20 |
| S19 | 6 | LCD driver output 19 |
| S18 | 7 | LCD driver output 18 |
| S17 | 8 | LCD driver output 17 |
| S16 | 9 | LCD driver output 16 |
| S15 | 10 | LCD driver output 15 |
| S14 | 11 | LCD driver output 14 |
| S13 | 12 | LCD driver output 13 |
| S12 | 13 | LCD driver output 12 |
| S11 | 14 | LCD driver output 11 |
| S10 | 15 | LCD driver output 10 |
| S9 | 16 | LCD driver output 9 |
| S8 | 17 | LCD driver output 8 |
| S7 | 18 | LCD driver output 7 |
| S6 | 19 | LCD driver output 6 |
| S5 | 20 | LCD driver output 5 |
| S4 | 21 | LCD driver output 4 |
| S3 | 22 | LCD driver output 3 |
| S2 | 23 | LCD driver output 2 |
| S1 | 24 | LCD driver output 1 |
| BP2 | 25 | backplane driver output 2 |
| BP1 | 26 | backplane driver output 1 |
| DATA | 27 | data input line (CBUS) |
| DLEN | 28 | data input line enable (CBUS) |

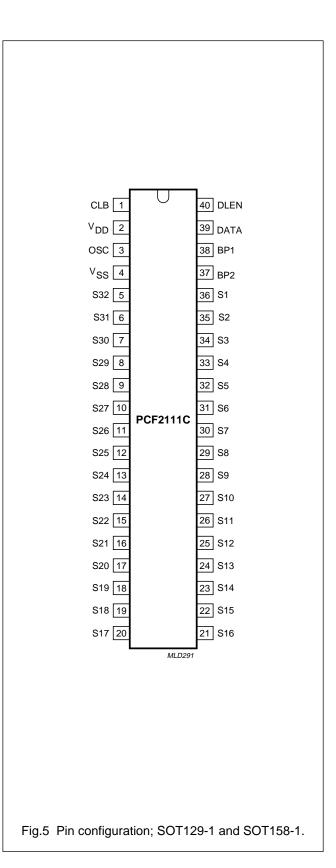


Product specification

PCF21xxC family

6.2 PCF2111C

| CLB1clock burst input (CBUS) V_{DD} 2supply voltageOSC3oscillator input V_{SS} 4supply voltage groundS325LCD driver output 32S316LCD driver output 31S307LCD driver output 30S298LCD driver output 29S289LCD driver output 28S2710LCD driver output 26S2512LCD driver output 25S2413LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1423LCD driver output 14 | | | | | | |
|--|-----------------|-----|--------------------------|--|--|--|
| V_{DD} 2supply voltageOSC3oscillator input V_{SS} 4supply voltage groundS325LCD driver output 32S316LCD driver output 31S307LCD driver output 30S298LCD driver output 29S289LCD driver output 28S2710LCD driver output 26S2512LCD driver output 25S2413LCD driver output 23S2215LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 17S1621LCD driver output 16S1522LCD driver output 14 | SYMBOL | PIN | DESCRIPTION | | | |
| OSC3oscillator inputV _{SS} 4supply voltage groundS325LCD driver output 32S316LCD driver output 31S307LCD driver output 30S298LCD driver output 29S289LCD driver output 28S2710LCD driver output 26S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 19S1819LCD driver output 19S1621LCD driver output 16S1522LCD driver output 14 | CLB | 1 | clock burst input (CBUS) | | | |
| V _{SS} 4 supply voltage ground S32 5 LCD driver output 32 S31 6 LCD driver output 31 S30 7 LCD driver output 30 S29 8 LCD driver output 29 S28 9 LCD driver output 28 S27 10 LCD driver output 27 S26 11 LCD driver output 26 S25 12 LCD driver output 25 S24 13 LCD driver output 24 S23 14 LCD driver output 23 S22 15 LCD driver output 21 S23 14 LCD driver output 21 S20 17 LCD driver output 20 S19 18 LCD driver output 19 S18 19 LCD driver output 19 S18 19 LCD driver output 17 S16 21 LCD driver output 16 S15 22 LCD driver output 15 S14 23 LCD driver output 14 | / _{DD} | 2 | supply voltage | | | |
| S32 5 LCD driver output 32 S31 6 LCD driver output 31 S30 7 LCD driver output 30 S29 8 LCD driver output 29 S28 9 LCD driver output 28 S27 10 LCD driver output 27 S26 11 LCD driver output 26 S25 12 LCD driver output 25 S24 13 LCD driver output 24 S23 14 LCD driver output 23 S22 15 LCD driver output 21 S20 17 LCD driver output 21 S20 17 LCD driver output 20 S19 18 LCD driver output 19 S18 19 LCD driver output 17 S16 21 LCD driver output 16 S15 22 LCD driver output 15 S14 23 LCD driver output 14 | DSC | 3 | oscillator input | | | |
| S31 6 LCD driver output 31 S30 7 LCD driver output 30 S29 8 LCD driver output 29 S28 9 LCD driver output 28 S27 10 LCD driver output 27 S26 11 LCD driver output 26 S25 12 LCD driver output 25 S24 13 LCD driver output 24 S23 14 LCD driver output 23 S22 15 LCD driver output 21 S20 17 LCD driver output 21 S20 17 LCD driver output 20 S11 16 LCD driver output 20 S12 16 LCD driver output 19 S18 19 LCD driver output 19 S18 19 LCD driver output 17 S16 21 LCD driver output 16 S15 22 LCD driver output 15 S14 23 LCD driver output 14 | V _{SS} | 4 | supply voltage ground | | | |
| S307LCD driver output 30S298LCD driver output 29S289LCD driver output 28S2710LCD driver output 27S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | 332 | 5 | LCD driver output 32 | | | |
| S298LCD driver output 29S289LCD driver output 28S2710LCD driver output 27S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 14 | S31 | 6 | LCD driver output 31 | | | |
| S289LCD driver output 28S2710LCD driver output 27S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 17S1621LCD driver output 16S1522LCD driver output 14 | S30 | 7 | LCD driver output 30 | | | |
| S2710LCD driver output 27S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 15S1423LCD driver output 14 | 329 | 8 | LCD driver output 29 | | | |
| S2611LCD driver output 26S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 14 | S28 | 9 | LCD driver output 28 | | | |
| S2512LCD driver output 25S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | 527 | 10 | LCD driver output 27 | | | |
| S2413LCD driver output 24S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S26 | 11 | LCD driver output 26 | | | |
| S2314LCD driver output 23S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S25 | 12 | LCD driver output 25 | | | |
| S2215LCD driver output 22S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | 524 | 13 | LCD driver output 24 | | | |
| S2116LCD driver output 21S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | 523 | 14 | LCD driver output 23 | | | |
| S2017LCD driver output 20S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | 522 | 15 | LCD driver output 22 | | | |
| S1918LCD driver output 19S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S21 | 16 | LCD driver output 21 | | | |
| S1819LCD driver output 18S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S20 | 17 | LCD driver output 20 | | | |
| S1720LCD driver output 17S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S19 | 18 | LCD driver output 19 | | | |
| S1621LCD driver output 16S1522LCD driver output 15S1423LCD driver output 14 | S18 | 19 | LCD driver output 18 | | | |
| S1522LCD driver output 15S1423LCD driver output 14 | S17 | 20 | LCD driver output 17 | | | |
| S14 23 LCD driver output 14 | S16 | 21 | LCD driver output 16 | | | |
| | S15 | 22 | LCD driver output 15 | | | |
| S13 24 I CD driver output 13 | S14 | 23 | LCD driver output 14 | | | |
| | S13 | 24 | LCD driver output 13 | | | |
| S12 25 LCD driver output 12 | S12 | 25 | LCD driver output 12 | | | |
| S11 26 LCD driver output 11 | S11 | 26 | LCD driver output 11 | | | |
| S10 27 LCD driver output 10 | S10 | 27 | LCD driver output 10 | | | |
| S9 28 LCD driver output 9 | S9 | 28 | LCD driver output 9 | | | |
| S8 29 LCD driver output 8 | 58 | 29 | LCD driver output 8 | | | |
| S7 30 LCD driver output 7 | | 30 | | | | |
| S6 31 LCD driver output 6 | S6 | 31 | LCD driver output 6 | | | |
| S5 32 LCD driver output 5 | S5 | 32 | | | | |
| S4 33 LCD driver output 4 | | | | | | |
| S3 34 LCD driver output 3 | | | · · | | | |
| S2 35 LCD driver output 2 | | | | | | |
| S1 36 LCD driver output 1 | | | | | | |
| BP2 37 backplane driver output 2 | | 37 | | | | |
| BP1 38 backplane driver output 1 | | | | | | |
| DATA 39 data input line (CBUS) | | | | | | |
| DLEN 40 data input line enable (CBUS) | | | | | | |

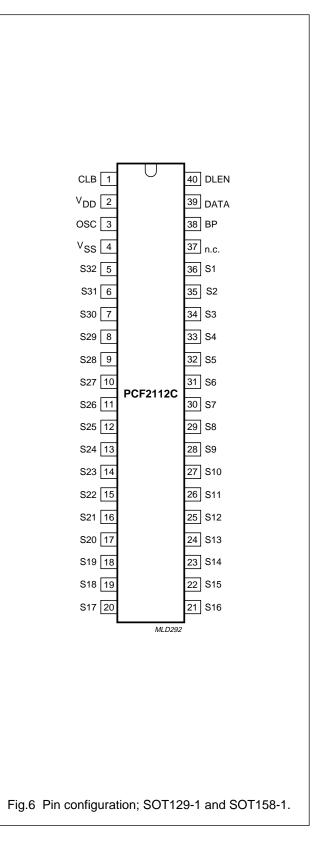


Product specification

PCF21xxC family

6.3 PCF2112C

| SYMBOL PIN | DESCRIPTION |
|---------------------|-------------------------------|
| L | |
| | lock burst input (CBUS) |
| V _{DD} 2 s | upply voltage |
| OSC 3 o | scillator input |
| V _{SS} 4 s | upply voltage ground |
| S32 5 L | CD driver output 32 |
| S31 6 L | CD driver output 31 |
| S30 7 L | CD driver output 30 |
| S29 8 L | CD driver output 29 |
| S28 9 L | CD driver output 28 |
| S27 10 L | CD driver output 27 |
| S26 11 L | CD driver output 26 |
| S25 12 L | CD driver output 25 |
| S24 13 L | CD driver output 24 |
| S23 14 L | CD driver output 23 |
| S22 15 L | CD driver output 22 |
| S21 16 L | CD driver output 21 |
| S20 17 L | CD driver output 20 |
| S19 18 L | CD driver output 19 |
| S18 19 L | CD driver output 18 |
| S17 20 L | CD driver output 17 |
| S16 21 L | CD driver output 16 |
| S15 22 L | CD driver output 15 |
| S14 23 L | CD driver output 14 |
| S13 24 L | CD driver output 13 |
| S12 25 L | CD driver output 12 |
| S11 26 L | .CD driver output 11 |
| S10 27 L | CD driver output 10 |
| S9 28 L | .CD driver output 9 |
| S8 29 L | CD driver output 8 |
| S7 30 L | .CD driver output 7 |
| S6 31 L | CD driver output 6 |
| S5 32 L | CD driver output 5 |
| S4 33 L | CD driver output 4 |
| S3 34 L | CD driver output 3 |
| S2 35 L | CD driver output 2 |
| S1 36 L | CD driver output 1 |
| n.c. 37 n | ot connected |
| BP 38 b | ackplane driver output |
| DATA 39 d | lata input line (CBUS) |
| | lata input line enable (CBUS) |



Product specification

PCF21xxC family

7 FUNCTIONAL DESCRIPTION

An LCD segment or LED output is activated when the corresponding DATA bit is HIGH.

7.1 PCF2100C

When DATA bit 21 is HIGH, the A-latches (BP1) are loaded. With DATA bit 21 LOW, the B-latches (BP2) are loaded. CLB pulse 23 transfers data from the shift register to the selected latches.

7.2 PCF2111C

When DATA bit 33 is HIGH, the A-latches (BP1) are loaded. With DATA bit 33 LOW, the B-latches (BP2) are loaded. CLB pulse 35 transfers data from the shift register to the selected latches.

7.3 PCF2112C

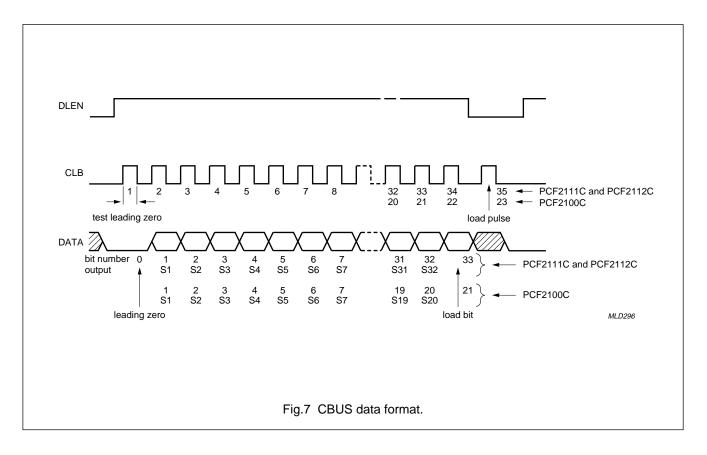
When DATA bit 33 is HIGH, the latches are loaded. CLB pulse 35 transfers data from the shift register to the selected latches.

7.4 Bus control logic

The following tests are carried out by the bus control logic:

- 1. Test on leading zero
- 2. Test on number of DATA bits
- 3. Test of disturbed DLEN and DATA signals during transmission.

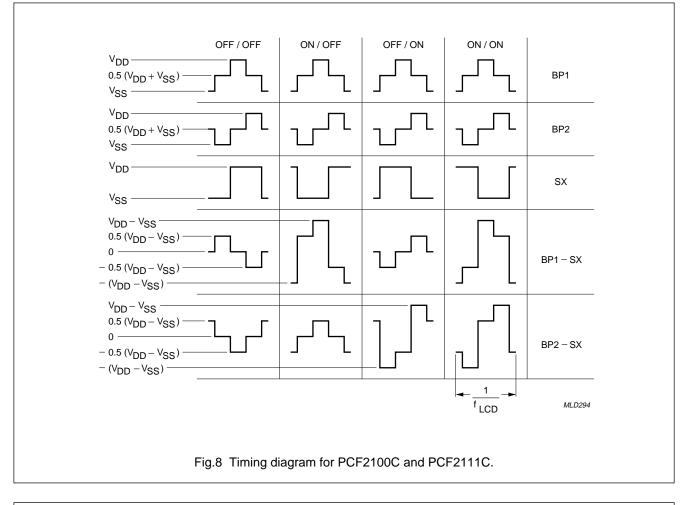
If one of the test conditions is not fulfilled, no action follows the load condition (load pulse with DLEN LOW) and the driver is ready to receive new data.

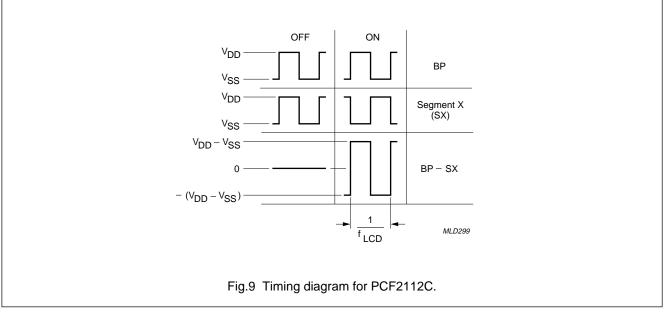


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PCF21xxC family

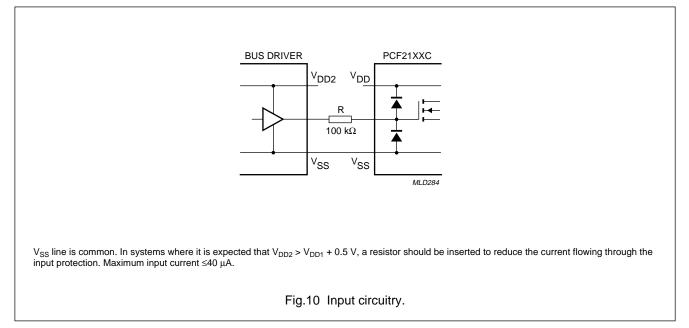
7.5 Timing



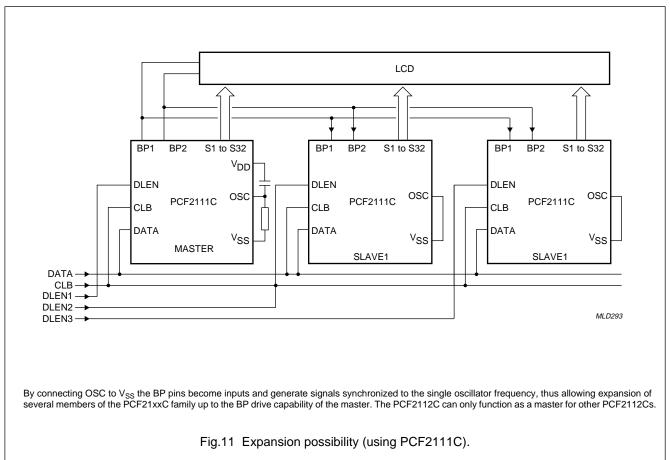


PCF21xxC family

7.6 Input circuitry



7.7 Expansion



PCF21xxC family

8 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------------------------------|---------------------------------------|------------|--------------|-----------------------|------|
| V _{DD} | supply voltage | | -0.5 | +8.0 | V |
| VI | input voltage DLEN, CLB, DATA and OSC | | $V_{SS}-0.5$ | V _{DD} + 0.5 | V |
| Vo | output voltage BP1, BP2 and S1 to S32 | | $V_{SS}-0.5$ | V _{DD} + 0.5 | V |
| I _{DD} , I _{SS} | supply current | | -50 | +50 | mA |
| l | DC input current | | -20 | +20 | mA |
| lo | DC output current | | -25 | +25 | mA |
| P _{tot} | total power dissipation per package | note 1 | - | 500 | mW |
| Po | power dissipation per output | | _ | 100 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |

Note

1. Derate by 7.7 mW/K when T_{amb} > 60 °C.

9 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take normal precautions appropriate to handling MOS devices. See *"Handling MOS devices"*.

ESD in accordance with "MIL STD 883C, Method 3015".

PCF21xxC family

10 DC CHARACTERISTICS

 V_{DD} = 2.25 to 6.0 V; V_{SS} = 0 V; T_{amb} = -40 to +80 °C; R_O = 1 M Ω ; C_O = 680 pF; unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------------------|-----------------------------------|---|------|------|------|------|
| Supply | | | I | | | 1 |
| V _{DD} | supply voltage | | 2.25 | _ | 6.0 | V |
| I _{DD} | supply current | note 1; see Fig.13 | - | 20 | 50 | μA |
| | | note 1; T _{amb} = 25 °C; see Fig.13 | - | 20 | 30 | μA |
| V _{POR} | power-on reset voltage level | note 2 | _ | 1.0 | 1.6 | V |
| Inputs CL | B, DATA and DLEN | | | | | |
| V _{IL} | LOW level input voltage | | _ | _ | 0.8 | V |
| V _{IH} | HIGH level input voltage | | 2.0 | _ | _ | V |
| ILI | input leakage current | $V_{I} = V_{SS} \text{ or } V_{DD}$ | - | _ | ±1 | μA |
| C _i input capacitance | | note 3 | _ | _ | 10 | pF |
| Input OSC | ; | | | | | |
| l _{osc} | oscillator start-up current | $V_{I} = V_{SS}$ | 0.5 | 1.2 | 5.0 | μA |
| LCD output | uts | • | | | 1 | • |
| V _{BP} | DC voltage of backplane drivers | | _ | ±20 | - | mV |
| Z _{O(BP)} | backplane driver output impedance | note 4; V _{DD} = 5 V | - | 0.5 | 5.0 | kΩ |
| Z _{O(S)} | segment driver output impedance | note 4; V _{DD} = 5 V | - | 1 | 7 | kΩ |

Notes

1. Outputs open; CBUS inactive.

2. Resets all logic, when $V_{DD} < V_{POR}$.

3. Periodically sampled (not 100% tested).

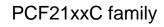
4. Outputs measured one at a time.

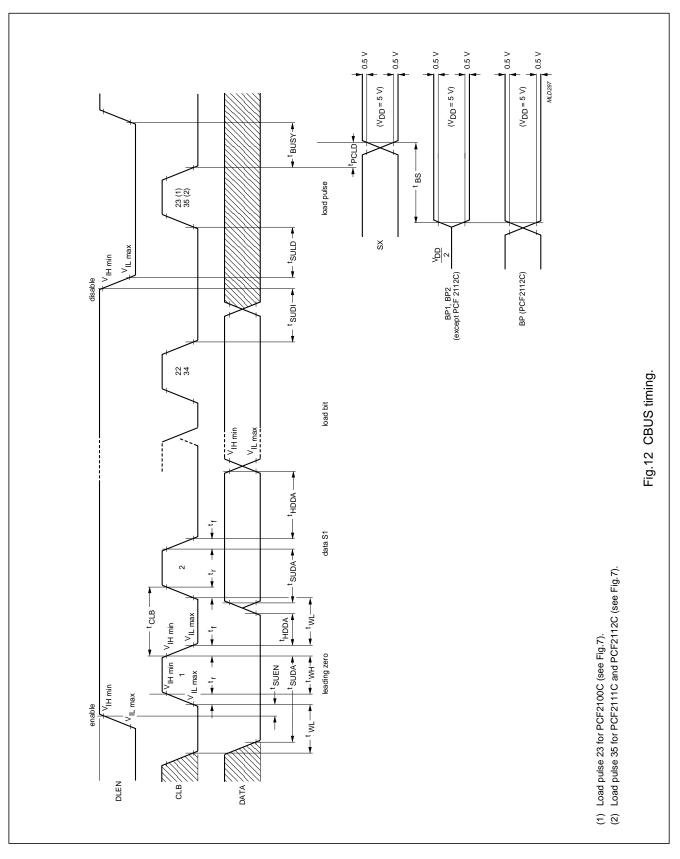
PCF21xxC family

11 AC CHARACTERISTICS

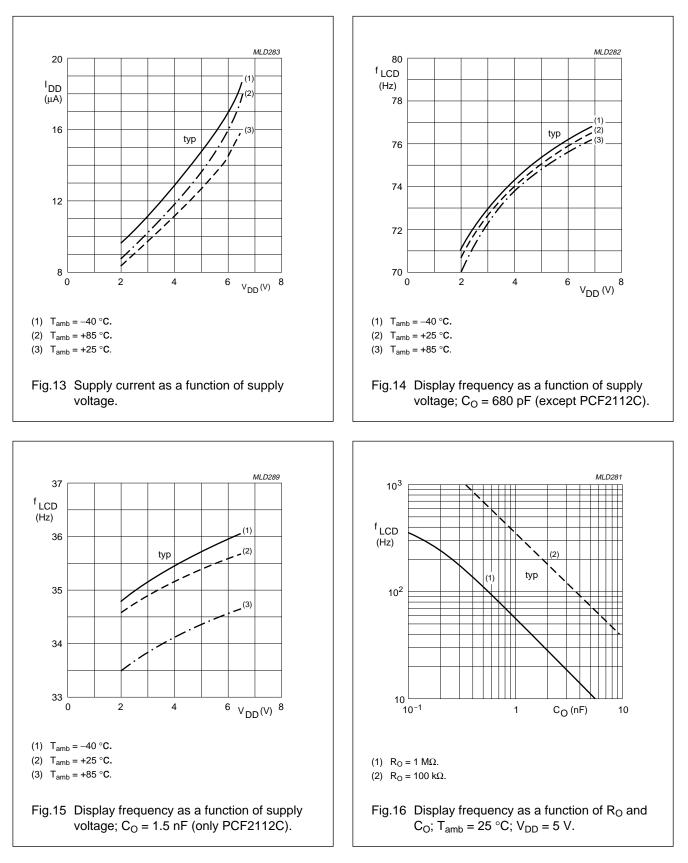
 $V_{DD} = 2.25 \text{ to } 6.0 \text{ V}; V_{SS} = 0 \text{ V}; T_{amb} = -40 \text{ to } +80 \text{ }^{\circ}\text{C}; R_{O} = 1 \text{ M}\Omega; C_{O} = 680 \text{ pF}; \text{ all timing values are referenced to } V_{IH} \text{ and } V_{IL} \text{ levels with an input voltage swing of } V_{SS} \text{ to } V_{DD}; \text{ unless otherwise specified.}$

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------|--|-------------------------|------|------|------|------|
| Inputs CLI | B, DATA and DLEN (see Fig.12) | • | | _ | - | |
| t _{SUDA} | data set-up time | | 3 | - | - | μs |
| t _{HDDA} | data hold time | | 3 | _ | - | μs |
| t _{SUEN} | enable set-up time | | 1 | - | - | μs |
| t _{SUDI} | disable set-up time | | 2 | _ | - | μs |
| t _{SULD} | load pulse set-up time | | 2.5 | - | - | μs |
| t _{BUSY} | busy time | | 3 | - | - | μs |
| t _{WH} | CLB HIGH time | | 1 | _ | - | μs |
| t _{WL} | CLB LOW time | | 5 | _ | - | μs |
| t _{CLB} | CLB cycle time | | 10 | - | - | μs |
| t _r | rise time | | _ | _ | 10 | μs |
| t _f | fall time | | _ | _ | 10 | μs |
| LCD timin | g (see Figs. 12, 14, 15, 16 and 17) | | | | | • |
| f _{LCD} | LCD frame frequency | | | | | |
| | PCF2100C, PCF2111C | | 60 | 75 | 100 | Hz |
| | PCF2112C | C _O = 1.5 nF | 30 | 35 | 50 | Hz |
| t _{BS} | transfer time with test loads | V _{DD} = 5 V | - | 20 | 100 | μs |
| t _{PLCD} | driver delay time with test loads | V _{DD} = 5 V | - | 20 | 100 | μs |

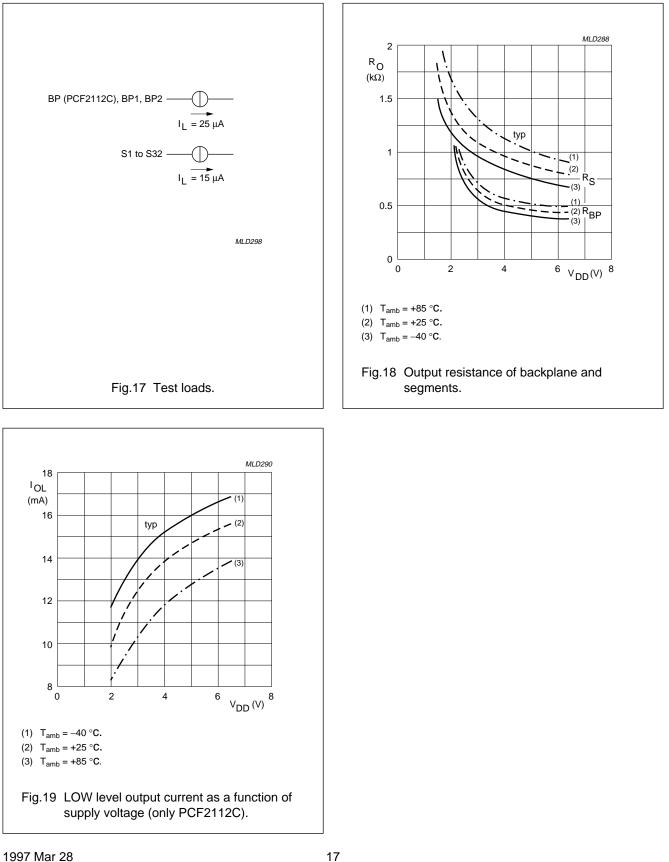




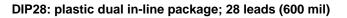
PCF21xxC family

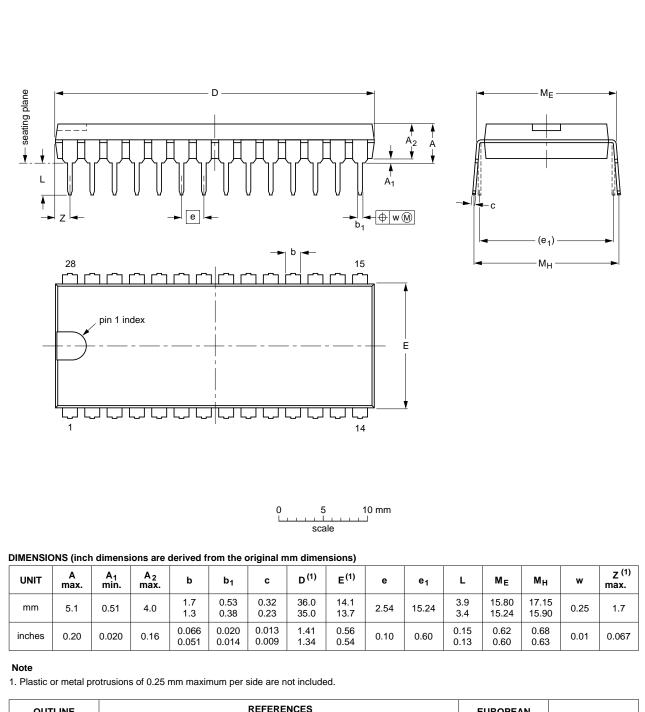


PCF21xxC family



12 PACKAGE OUTLINES





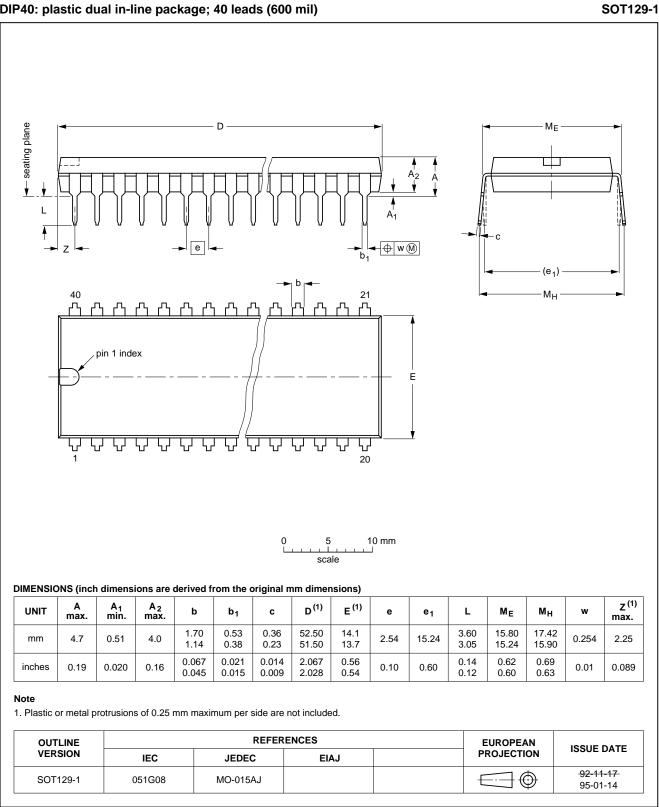
| OUTLINE | | REFER | ENCES | EUROPEAN | ISSUE DATE |
|----------|--------|----------|-------|------------|----------------------------------|
| VERSION | IEC | JEDEC | EIAJ | PROJECTION | ISSUE DATE |
| SOT117-1 | 051G05 | MO-015AH | | | -92-11-17 95-01-14 |

Product specification

SOT117-1

PCF21xxC family

PCF21xxC family

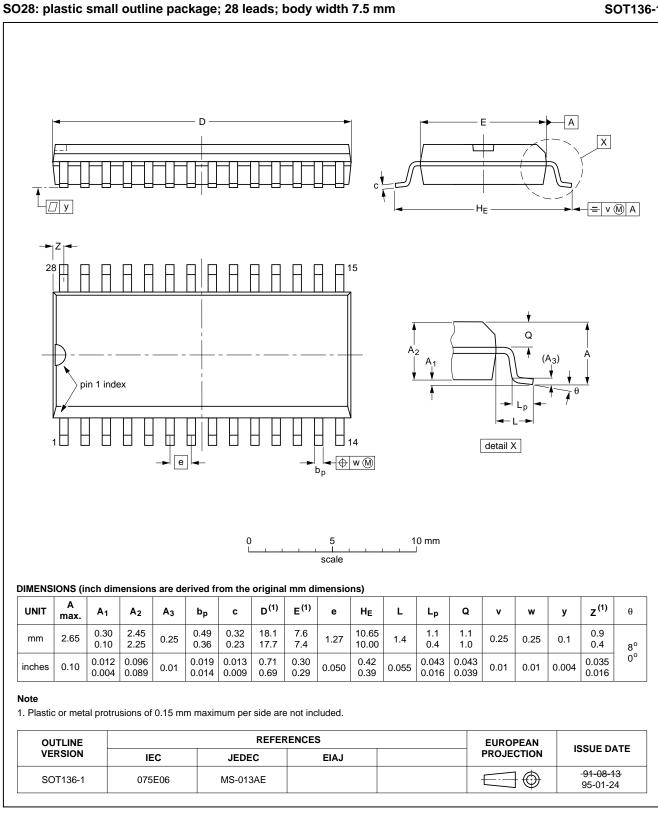


DIP40: plastic dual in-line package; 40 leads (600 mil)

1997 Mar 28

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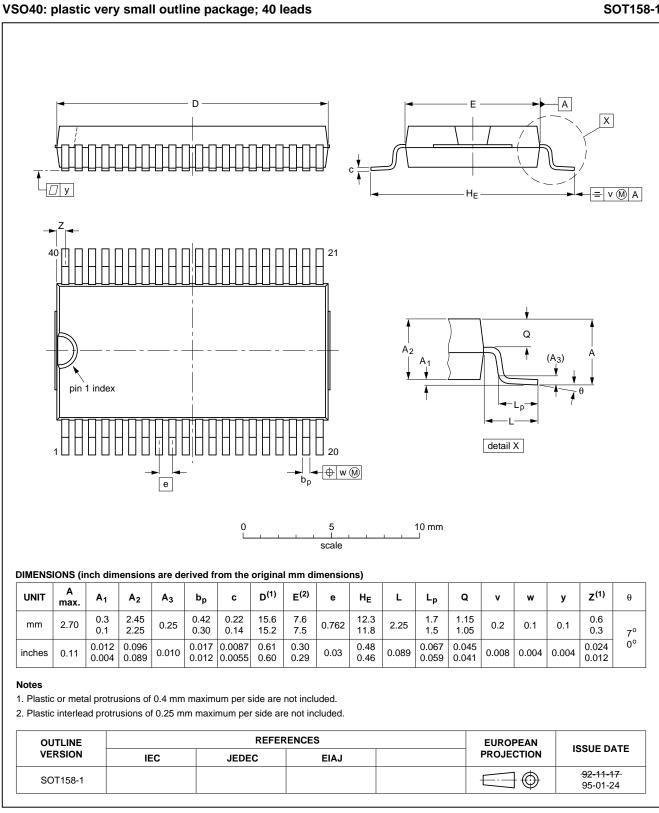
PCF21xxC family



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SOT136-1

PCF21xxC family



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SOT158-1

PCF21xxC family

13 SOLDERING

13.1 Introduction

There is no soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and surface mounted components are mixed on one printed-circuit board. However, wave soldering is not always suitable for surface mounted ICs, or for printed-circuits with high population densities. In these situations reflow soldering is often used.

This text gives a very brief insight to a complex technology. A more in-depth account of soldering ICs can be found in our *"IC Package Databook"* (order code 9398 652 90011).

13.2 DIP

13.2.1 SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg max}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

13.2.2 REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the lead(s) of the package, below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

13.3 SO and VSO

13.3.1 REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO and VSO packages.

Reflow soldering requires solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the printed-circuit board by screen printing, stencilling or pressure-syringe dispensing before package placement. Several techniques exist for reflowing; for example, thermal conduction by heated belt. Dwell times vary between 50 and 300 seconds depending on heating method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 minutes at 45 °C.

13.3.2 WAVE SOLDERING

Wave soldering techniques can be used for all SO and VSO packages if the following conditions are observed:

- A double-wave (a turbulent wave with high upward pressure followed by a smooth laminar wave) soldering technique should be used.
- The longitudinal axis of the package footprint must be parallel to the solder flow.
- The package footprint must incorporate solder thieves at the downstream end.

During placement and before soldering, the package must be fixed with a droplet of adhesive. The adhesive can be applied by screen printing, pin transfer or syringe dispensing. The package can be soldered after the adhesive is cured.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder is 10 seconds, if cooled to less than 150 °C within 6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal of corrosive residues in most applications.

13.3.3 REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonallyopposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

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PCF21xxC family

14 DEFINITIONS

| Data sheet status | |
|---------------------------|--|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Short-form specification | The data in this specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook. |

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

15 LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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